

W. W. Hansen Experimental Physics Laboratory

STANFORD UNIVERSITY STANFORD, CALIFORNIA 94305 - 4085

Gravity Probe B Relativity Mission

SQUID Kit / Readout Test Readiness Review

GP-B P0257 Rev -

February 20, 1998

Prepared by: Ken Hooper Systems Engineer	Date
Systems Engineer	
Approved by: Bob Schultz	Date
Chief Systems Engineer	
Approved by: Barry Muhlfelder Manager, SQUID Development	Date
Approved by: George "Mac" Keiser Chief Scientist	Date
Approved by: Jim Lockhart SRE IPT Leader	Date
Approved by: B. Taller Quality Assurance	Date

Approved by: J. Turneaure Hardware Manager

Date

SQUID Kit / Readout Test Readiness Review

Date & Time: December 18, 1997, 2:00 to 4:00 PM

Location: GP-B conference room

Purpose:

To ensure that the test article hardware, test facility, ground support personnel, and test procedures are ready for testing, data acquisition, reduction, evaluation, and control.

Scope:

The SQUID Kit / Readout Test Readiness Review (TRR) will encompass all SQUID Kit / Readout (RO) flight hardware. The RO flight hardware includes the completed SQUID Kits assemblies and their components, including: the SQUID packages, their sensors, cables, connectors, brackets and mounting hardware.

Agenda:

- Requirements Traceability Status
- Procedure Status
- Test Personnel Status
- Test Resources Status
- Test Support Software Status

Review Team:

John Turneaure	Hardware Manager
Barry Muhlfelder	Manager, SQUID Development
George "Mac" Keiser	Chief Scientist
Jim Lockhart	SRE IPT Leader
Ben Taller	Quality Assurance
Bob Schultz	Chief Systems Engineer
Ken Hooper	Review Leader
Ed Ingraham	ONR (ex officio)

Objectives:

- Confirm that in-place test plans and procedures meet verification requirements and specifications.
- Confirm that sufficient and detailed resources (of the right type) are allocated to the test effort.
- Examine detailed test procedures for completeness and safety during test operations. Note who is in charge of the test operations and test article and who is in charge of the facilities.
- Determine the critical test personnel who are authorized to perform test.
- Confirm that test support software is adequate, pertinent, and verified (validated for intended use).
- Confirm that all interfaces with the test article, test equipment, and facilities, especially power, data, instrumentation, etc., are adequate, safe, and in accordance with the test procedure. Ensure the customer, witnessing agents, test personnel, quality assurance, and support personnel understand the objective of the test and the parameters that are critical for successful operation.
- Confirm that the documentation has proper traceability.
- Confirm that test equipment has been appropriately calibrated.

Exit Criteria:

The following items identify the categories of items to be checked; the individual checks are enumerated in the attached checklists:

- Do the test procedures verify all applicable requirements?
- Have test personnel received training in test operations procedures?
- Are resources available to adequately support the planned tests as well as contingencies, including failed hardware replacement?
- Has the test support software been demonstrated to handle test configuration assignments, and data acquisition, reduction, evaluation, control, and archiving?

Attachments:

- A. Manufacturing Flow Diagrams
- B. Requirements Verification Matrix
- C. Document Status Checklist
- D. Test Personnel Status Checklist
- E. Test Resources Checklists and Test Support Software Checklist
- F. Completion Certificate

A. SQUID Kit / Readout Manufacturing Flow

		SQUID Carrier Hardware Flow
		P0152 SQUID Carrier Substrate Fabrication
		P0317 SQUID Carrier Substrate Cleaning
		P0164 SQUID Die Pre-screening Procedure P0380 Fabrication Procedure for SQUID
		Feedback Transformers
Bracket and Heater Hardware Flow		P0156 Feedback Transformer Verification
P0117 SQUID Bracket Assembly Procedure P0120 Heater Assembling, Chip Resistor		P0155 Output Transformer Fabrication Verification
P0182 Heater Assembly, Chip Resistor		P0153 SQUID Carrier Assembly & Process Endurance Testing
P0116 Temperature Sensor Assy Procedure		P0157 Use of Epoxy Stycast 1266 Procedure
P0102 SQUID Readout Cable Assembly	SOLUD Deckage Handware Flow	
P0110 Output Cable Sub Assembly	SQUID Package Hardware FlowP0161 SQUID Capacitor Kit Assembly	P0158 Lead Gasket Fabrication
P0169 Thermal Ground Kit	SC Cable Connection	P0159 SQUID Package Assembly
P0080 Cryogenic Magnetic Screening Procedure	2	
	P0160 SQUID Package Testing and	
P0166 System Integration	I	

P0170 Readout Shake Test

B. SQUID Kit / Readout Verification Matrix

Section	Title	Text & Comments	Method	Verification Plan	RE	ECD	\checkmark
3.2	Accuracy						
3.2.1	Linearity	The readout system meets the following linearity requirements in the					
		presence of trapped flux levels as specified in requirement 1.5:					
3.2.1.1	High Frequency	In the frequency range 100-1000 Hz the harmonic distortion of each of	T(D)	Preliminary test in P0160 SQUID	В	4/98	11
		harmonics 2-6 of sinusoids with amplitude corresponding to the		Package Testing and Verification	Muhlfelder		1
		trapped flux levels of section 1.5 shall be less than 1e-4.		Will be verified during SRE testing		E	\parallel
3.2.1.2	Low Frequency	For frequencies less than 1 Hz, the harmonic distortion of each	T(A)	Preliminary test in P0160 SQUID	В	4/98	11
		harmonic 2-6 of sinusoids with amplitude up to 80 arcsec London		Package Testing and Verification	Muhlfelder	E	\parallel
		moment equivalent shall be less than 1e-4.		Will be verified during SRE testing			\mathcal{U}

SQUID Kit / Readout Requirements from System Design and Performance Requirements Spec. [T003]

SQUID Kit / Readout Requirements from SIA Specification [PLSE-12 F277277 §3.7.1.7]

Section	Title	Text & Comments		Verification Plan	RE	ECD 🗸
3.7.1.7	SQUID Kit					
3.7.1.7.1	Prime Item Definition	A SQUID kit consists of two SQUID Packages, each containing one SQUID Sensor, the cables connecting the above components to the cold end Probe connectors, and the SQUID bracket (providing the components for thermal control) and other mounting hardware required to hold the above components in place. There are two SQUID kits in the SIA.				
3.7.1.7.1 .1 3.7.1.7.1 .1.2	Prime Item Diagrams SQUID Package					
3.7.1.7.1 .2	Interface Definition					
3.7.1.7.1 .2.1	Functional Interfaces	The SQUID kit shall interface through the probe cables to the SQUID forward Electronics for power and operational control (Section 3.7.1.7.1.2.2), for thermal control (Section 3.7.1.7.1.2.4), and to deliver Science Signals (Section 3.7.1.7.1.2.2). It shall interface to each Science Gyroscope through its Superconductive Cable. It shall interface to the structure of the Probe through the SQUID Mounting Bracket.	Ι	Inspect to drawings 25132-101 (NEG X), and 25132-102 (POS X)	B Muhlfelde r	4/98 ✓

3.7.1.7.1 .2.2	Signal Interfaces	Each SQUID kit shall have the following electrical inputs and outputs.	Ι	Inspect to drawings 25132-101 (NEG X), and 25132-102 (POS X)	B Muhlfelde	4/98	✓
		 Bracket instrumentation inputs and outputs a. Input drive currents to two GRTs. 			r		
		b. Output signal voltages from two GRTs.					
		c. Two SQUID bracket heater current inputs (one prime & one spare).					
		2. The following inputs and output to/from each of the two SQUID					
		packages contained in a SQUID kit for connection to the SQUID forward electronics.					
		a. Bias current input.					
		b. Modulation signal input.					
		c. Feedback signal input.					
		d. Voltage signal output.					
		3. The following input to each of the two SQUID packages contained in					
		a SQUID kit for connection to the gyroscope pickup loop.					
		a. Gyroscope pickup loop flux signal.					
3.7.1.7.1	Electrical Interfaces	The SQUID hardware shall interface to the cold end connectors as	Ι	Inspect to drawings 25132-101 (NEG	D Bardas	5/98	\checkmark
.2.3		shown in LMSC drawing 1C34103		X), and 25132-102 (POS X)			
3.7.1.7.1	Thermal Interfaces	The operating temperature of each SQUID Package shall be maintained	Ι	To be verified at payload testing	В	5/98	
.2.4		as specified in Sections 3.7.1.7.2.1.6.4 and 3.7.1.7.2.1.6.5 by an active			Muhlfelde		
		thermal control system that uses a GRT and a heater mounted on each			r		
		SQUID Bracket. The Probe maintains a temperature at the mounting as					\parallel
		specified in Section 3.7.2.5. The total power delivered to the SQUID					
27171	Marken's 1	Bracket shall not exceed that specified in 3.7.2.5.7	т	Lease 44 - Lease 25122 101 (AFEC	D D l	5/00	\sim
3.7.1.7.1 .2.5	Mechanical Interfaces	Each SQUID Bracket shall interface to the Probe Quartz Block Support	Ι	Inspect to drawings 25132-101 (NEG X), and 25132-102 (POS X)	D Bardas	5/98	v
3.7.1.7.2	Characteristics	structure as shown in LMMS drawing 1C34103.		A), and 25152-102 (POS A)			
3.7.1.7.2	Performance	In the specifications below, the conversion from flux signal in the					
.1	renormance	SQUID input loop to angle equivalent signal assumes a four turn					
•1		pickup loop, a 130 Hz spin speed, and a 3 minute roll period.					
3.7.1.7.2	Noise at 5.5	The SQUID sensor noise shall have a magnitude less than 140	Т	P0160 SQUID Package Testing and	В	4/98	\checkmark
.1.1	milliHertz	marcsec/Hz^0.5 equivalent at 5.5 mHz (single-sided).		Verification	Muhlfelde	., >0	
					r		
3.7.1.7.2	Noise at 130 Hertz	The SQUID sensor noise shall have a magnitude less than 60	Т	P0160 SQUID Package Testing and	В	4/98	✓
.1.2		marcsec/Hz^0.5 at 130 Hz, where the flux to angle scale factor assumes		Verification	Muhlfelde		
		a rotating trapped dipole flux level equal to the London dipole moment			r		
		at 130 Hz (this trapped flux level is an assumption only, and does not occur in fact).					
3.7.1.7.2	DC Linearity	The V-flux characteristic of the SQUID sensor shall have a linearity	S	A qualification unti will be tested in	В	4/98	\checkmark
.1.3	-	better than 1% over a +/- 100 arcsec range of uncompensated error.		P0160 SQUID Package Testing and	Muhlfelde		
				Verification	r		

3.7.1.7.2	Harmonic Distortion	The harmonic distortion of the SQUID operating with flux-locked-loop	Т	P0160 SQUID Package Testing and	B 4	/98 🗸
.1.3.1		electronics having a disturbance rejection in the range of 100-200 for		Verification	Muhlfelde	
		signals as specified in 3.7.1.5.2.1.1 shall be less than 10 ⁻⁴			r	
3.7.1.7.2	SQUID Thermal					
.1.4	Characteristics					

3.7.1.7.2	Operating Temperature Range	(a) The nominal operating temperature range is defined in 3.4 of T003, and it is the range over which all other performance requirements must	a) N/A (b) T	Test during acceptance testing of SQUID package.	B Muhlfelde	4/98	~
.1.4.1	Temperature Kange	be met. (b) The functional operating temperature range is 2.5 K to 4.2 K, and it is the range over which the only requirement is that the SQUID shall be able to be flux locked.	(0) 1	P0160 SQUID Package Testing and Verification	r		
3.7.1.7.2 .1.4.2	SQUID Bias Temperature Coefficient	The SQUID shall have a bias temperature coefficient of less than 0.01 flux quanta/K over the temperature range 2.7 K - 3K	Т	P0160 SQUID Package Testing and Verification	B Muhlfelde r	4/98	~
3.7.1.7.2 .1.4.3	SQUID Scale Factor Temperature Coefficient	The SQUID shall have an input current-to-SQUID flux transfer coefficient whose temperature coefficient is less than 3.0x10 ⁻⁴ in the range 2.7-3K	Т	P0160 SQUID Package Testing and Verification	B Muhlfelde r	4/98	~
3.7.1.7.2 1.4.4	Temperature Stability	Deleted. Requirement intent moved to 3.7.1.7.2.1.16 SQUID Bracket Thermal Characteristics.					
3.7.1.7.2 1.4.5	Temperature Drift	Deleted. Requirement intent moved to 3.7.1.7.2.1.16 SQUID Bracket Thermal Characteristics.					
3.7.1.7.2 1.5	Flux Jumps	There shall be no more than 1 flux jump per day with an amplitude in the range of 1 to 20 arcsec. There shall be no flux jumps with an amplitude exceeding 20 arcsec.	A	Analysis: S0295 On-Orbit Proton Induced Flux Jump Rate, P0160 SQUID Package Testing and Verification	B Muhlfelde r	6/98	~
3.7.1.7.2 1.6	Input Coil Impedance	The SQUID sensor input coil shall have an inductance less than 2.0 microhenry and shall be stable to 5 parts per million per year.	I,A	Inspection of manufacturer data - in hardware folder. Analysis: S0296 Input Coil Feedback Transformer and Input Circuit Stability	B Muhlfelde r	6/98	~
3.7.1.7.2 1.7	Damping of Cable to Package Joint	The decay time of the SQUID Package Input circuit and Cable to package joint shall be less than 1% in 10 min.	Т	P0160 SQUID Package Testing and Verification Re-verified at payload test	B Muhlfelde r	8/98	
3.7.1.7.2 1.8	Feedback Transformer Coupling	The SQUID Feedback Transformer shall have mutual inductance of 0.35 microhenry to 0.45 microhenry and shall be stable to 5 parts per million per year.	A,S	Analysis: S0296 Input Coil Feedback Transformer and Input Circuit Stability Similarity: Qual. unit tested in P0156 Feedback Transformer Verification	B Muhlfelde r	5/98	
3.7.1.7.2 1.9	Electrical Isolation	The resistance between any two of the following shall be greater than 20 megaohms: bias, modulation, feedback, and signal.	Т	P0160 SQUID Package Testing and Verification (Will be re-verified after integration with probe.)	B Muhlfelde r	4/98	~
3.7.1.7.2 1.10	Pickup Loop to SQUID Coupling	The Pickup Loop shall have a coupling to the SQUID better than 40 fA/marcsec. The coupling shall have as a goal a stability of one part in 100,000 per year.	A	S0296 Input Coil Feedback Transformer and Input Circuit Stability. A functional test will be performed at Payload level to verify input configuration	B Muhlfelde r	8/98	~

3.7.1.7.2 .1.11	Input Circuit Mutual Inductance Stability	The mutual inductance of input coil to SQUID loop shall be stable to better than 5 parts in 1.0e6 per year.	A	S0296 Input Coil Feedback Transformer and Input Circuit Stability	B Muhlfelde r	5/98 🗸
3.7.1.7.2 .1.12	SQUID Bias Current	The SQUID sensor shall have a bias current between 20 microampere and 60 microampere.	Т	P0160 SQUID Package Testing and Verification	B Muhlfelde r	8/98 ✓
3.7.1.7.2 .1.13	Modulation Coil to SQUID Mutual Inductance	The mutual inductance shall be between 1.3 nH and 1.5 nH.	Ι	Inspection of vendor acceptance data package - in hardware folder	B Muhlfelde r	 ✓
3.7.1.7.2 .1.14	Input Filter Capacitance	The capacitance from each contact block to ground shall be between 8 nF and 13 nF.	Т	P0161 SQUID Capacitor Kit Assembly	B Muhlfelde r	~
3.7.1.7.2 .1.15	SQUID Package AC Magnetic Shielding	The SQUID package shall provide ac shielding such that flux coupling from an applied external magnetic field shall be <= 1.0e-7 flux- quanta/pT (flux is referred to flux in SQUID loop). The applied external field is the free magnetic field applied to the exterior of the SQUID package.	<u>S</u> Ŧ	P0160 SQUID Package Testing and Verification	B Muhlfelde r	✓
3.7.1.7.2 .1.16	SQUID Bracket Thermal Characteristics	The thermal design of the SQUID bracket (including GRTs & heaters), SQUID packages, and related electrical cables shall have the capability to meet the requirement in 3.4 of T003.	A	Analysis of thermal design to verify capability to meet requirements (stability requires temperature control electronics). S0297 SQUID Bracket Thermal Characteristics	B Muhlfelde r	6/98 ✓
3.7.1.7.2 .1.16.1	Germanium Resistance Thermometer Characteristics	The GRTs shall have a nominal resistance of 1500Ω to 2500Ω at 4.2 K and be calibrated over the temperature range 2.5 K to 20 K with an accuracy of 5 mK over the temperature range from 2.5 K to 10 K.	Ι	Inspection of calibration data provided by vendor - in hardware folder.	B Muhlfelde r	4/99 ✓
3.7.1.7.2 .1.16.2	Heater Resistance	The heaters shall have a resistance of 1320 ohm +/- 100 ohm at 4.2 K.	Т	P0120 Heater Assembling, Chip Resistor	B Muhlfelde r	4/98 🗸
3.7.1.7.2 .1.16.3	Heater Dipole Moment due to Current	The heaters shall have a current induced magnetic dipole moment < 2.0e-9 A-m ² /mA (2.0e-6 emu/mA).	S	Similarity to qual unit test	B Muhlfelde r	2/98 ✓
3.7.1.7.2 .1.16.4	Thermal Delay Time	The time delay from heat applied to the SQUID bracket to the response at the GRT on the bracket shall be less than 1 s. Will be tested in component-level tests for the Science Mission. Will be tested in GTU-2 integrated test.	A	Using design & data from GTU-2	J Lockhart	
3.7.1.7.2 .1.17	Flux Slipping	It shall be possible to slip a flux quantum in the SQUID loop with a measurement error of less than 1 part in 10 ⁵ .	Т	P0160 SQUID Package Testing and Verification.	B Muhlfelde r	4/98 🗸

C. SQUID Kit / Readout Requirements Verification Documents Checklist

Readout Fabrication & Assembly

Document	Revision Date	Author	Title	Written	In	Approval	Dwg	Flow	Verif
					Database	Status	Ref	Ref	Ref
P0102	2/1/93	M Luo	SQUID Readout Cable Assembly	\checkmark	\checkmark	Approved		\checkmark	
P0110	ECD 2/5/98	M Luo	Output Cable Sub Assembly				\checkmark	\checkmark	
P0116	ECD 4/30/98	D Bardas	Temperature Sensor Assy Procedure				\checkmark	\checkmark	
P0117	ECD 3/25/98	B Muhlfelder	SQUID Bracket Assy Procedure				\checkmark	\checkmark	
P0119	ECD 3/11/98	B Muhlfelder	Clip Kit						
P0120	1/16/98	M Luo	Heater Assembling, Chip Resistor	\checkmark	\checkmark	Approved	\checkmark	\checkmark	
P0152 A	7/15/97	R Shile	SQUID Carrier Substrate Fabrication	\checkmark	\checkmark	Approved	\checkmark	\checkmark	
P0153 A	7/15/97	R Shile	SQUID Carrier Assembly & Process Endurance Testing	\checkmark	\checkmark	Approved	\checkmark	\checkmark	
P0155	11/21/95	M Luo	Output Transformer Fabrication Verification	\checkmark	\checkmark	Approved	\checkmark	\checkmark	
P0157	11/27/95	M Luo	Use of Epoxy Stycast 1266 Procedure	\checkmark	\checkmark	Approved			
P0158	12/13/95	M Luo	Lead Gasket Fabrication	\checkmark	\checkmark	Approved	\checkmark		
P0159	8/8/97	M Luo	SQUID Package Assembly	\checkmark	\checkmark	Approved	\checkmark	\checkmark	
P0161	ECD 3/4/98	M Luo	SQUID Capacitor Kit Assembly			Draft		\checkmark	
P0166	12/13/95	B Muhlfelder	System Integration	\checkmark	\checkmark	Approved		\checkmark	
P0169	ECD 3/11/98	D Hipkins	Thermal Ground Kit			Draft	\checkmark		
P0182	ECD 4/15/98	D Bardas	Heater Assembly, Chip Resistor			Draft	\checkmark		
P0380	ECD 2/18/98	R Shile	Fabrication Procedure for SQUID Feedback Transformers					\checkmark	

Readout Test

Document	Revision	Author	Title	Written	In	Approval	Dwg	Flow	Verif
	Date				Database	Status	Ref	Ref	Ref
P0156	11/21/95	R Shile	Feedback Transformer Verification	\checkmark	✓	Approved	\checkmark	\checkmark	\checkmark
P0160 A	1/8/98	B Muhlfelder	SQUID Package Testing and Verification	\checkmark	\checkmark	Approved			\checkmark
P0164	12/13/95	V Chiang/	SQUID Die Pre-screening Procedure	\checkmark	\checkmark	Approved		~	
		M Luo							
P0170	1/29/96	B Muhlfelder	Readout Shake Test	\checkmark	\checkmark	Approved		~	
P0387 A		B Muhlfelder	Pickup Loop Resistance Measurement	\checkmark	\checkmark	Approved		(SG)	

Additional Documents

Document	Date	Author	Title	Written	In	Approval	Dwg	Flow	Verif
					Database	Status	Ref	Ref	Ref
P0057 A	9/29/94	J Lockhart	GP-B Magnetic Control Plan - Science Mission	\checkmark		Approved	\checkmark		
P0059 C	6/19/94	M Keiser	Probe C Contamination Control Plan	\checkmark	\checkmark	Approved	\checkmark		
P0080	9/5/97	J Lockhart	Cryogenic Magnetic Screening Procedure	\checkmark	\checkmark	Approved	\checkmark		
23200-107 E	10/20/94	B Taller	DRAWING TREE, SQUID KIT, NEG X, SM	\checkmark		Released	\checkmark		
	ECO 1/30/98								
23200-117 C	8/3/96	B Taller	DRAWING TREE, SQUID KIT, POS X, SM	\checkmark		Released	\checkmark		
	ECO 1/30/98								
25132-101			SQUID KIT, NEG X				\checkmark		\checkmark
25132-102			SQUID KIT, POS X				\checkmark		\checkmark
S0295	ECD 4/30/98	B Muhlfelder	On-Orbit Proton Induced Flux Jump Rate						\checkmark
S0296	ECD 4/30/98	B Muhlfelder	Input Coil Feedback Transformer and Input Circuit						\checkmark
			Stability						
S0297	ECD 4/30/98	B Muhlfelder	SQUID Bracket Thermal Characteristics						\checkmark
S0302	ECD 3/20/98	B Muhlfelder	Results of SQUID Qualification Tests						

D. SQUID Kit / Readout Test Personnel Status Checklist

Test Conductors / Inspectors for the SQUID Kit / Readout Test Facilities

Name	Received Training in Test Operations			
Barry Muhlfelder				
Dale Gill				
M Luo				
R Shile				
Marge Bogan				

Qualified Test Directors for SQUID Kit / Readout

Name

Barry Muhlfelder

Procedures Requiring Director Approval

#	Title
P0153 A	SQUID Carrier Assembly & Process Endurance Testing
P0160	SQUID Package Testing and Verification
P0170	Readout Shake Test

E. SQUID Kit / Readout Test Resources Checklists

Instruments requiring standard calibration

Item Description	Seq.#	ID / Serial #	Next Cal.	Available
			Date	
HP 4277A LCZ meter with 16047A test fixture		0000864623	2/9/99	✓
		1		
Keithley 580 Micro-ohmmeter		0000128909	10/98	\checkmark
		1		
HP 54601A Oscilloscope	29	3227A06648	5/7/98	\checkmark
SR 345 Function Generator	28	26434	2/4/99	\checkmark
BTI model CCS Current Source	31	262490-04	5/22/98	\checkmark
HP8620C Oscillator	33	1604A00504	3/7/98	\checkmark
Fluke 77 Hand Meter		66970626	7/98	\checkmark
Quantum Design 5000 electronics	55	0000122596	7/1/98	\checkmark
		9		
SR 560 preamplifier	27	00204	5/22/98	\checkmark
Network Analyzer SR770	30	24185	2/5/99	\checkmark
Keithley 196 Multimeter	34	0575473	5/7/98	✓

Instruments requiring non-standard calibration

Item Description	Seq.#	ID / Serial #	Next Cal.	Available
			Date	
Rev B SQUID electronics	54	0001	7/1/98	\checkmark
Strawberry Tree Data Acquisition System				\checkmark

Facilities

SQUID Acceptance Probe
SQUID Acceptance Dewar
Clean Room 130, 132
Readout Clean Area
Readout EMI Screen Room
Readout General Assembly Area

Test Support Software

Software Product	Environment	Version	Controlled
Strawberry Tree WORKBENCH	PC DOS	V2.1.0	N/A
log1.wbw	WORKBENCH	-	\checkmark
log1.smpump.wbw	WORKBENCH	-	\checkmark
Matlab	Windows 3.1	4.2c.1	N/A
bkcrunch.m	Matlab	-	\checkmark

SQUID Kit / Readout TRR Action Items

#	Action	Assignee	ECD	Status as of 2/27/98
1	Have procedures P0317, P0157, P0160 and P0080 approved	B Muhlfelder & J Lockhart	1/9/98	done
2	Provide ECD dates for procedures & additional doc's not yet approved	B Muhlfelder	1/9/98	done
4	PCB for all proposed spec. changes & corresponding change to Science Gyro Assembly to include deflux heaters	K Hooper	Jan. PCB	done
5	Reword & modify verification of SIA rqmt. 3.7.1.7.2.1.3.1 & 3.7.1.7.2.1.4	B Muhlfelder & J Lockhart	Jan. PCB	done
6	Include pickup loop to SQUID coupling functional test	D Pickett		done
7	Review SQUID bias critical current rqmt.	J Lockhart & B Muhlfelder	Jan. PCB	done
8	Review modulator coil to SQUID mutual inductance verification data generated by Quantum Design	B Muhlfelder	acceptance review	
9	QA & SE to define how to capture verification data	QA (B Taller) & SE (B Schultz/K Hooper)	acceptance review	
10	Release SQUID Kit drawing tree	B Muhlfelder	acceptance review	